Zener Diode

Unit: mm

0.39

#### DZ26200×0L

# **Panasonic**

### DZ26200×0L

### Silicon epitaxial planar type

For constant voltage / For surge absorption circuit DZ27200 in ML2 type package

#### ■ Features

- Excellent rising characteristics of zener current IZ
- · Low zener operating resistance RZ
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol : ZJ or ZU

#### ■ Packaging

Embossed type (Thermo-compression sealing) 10 000 pcs / reel (standard)

1. 2. Pana JE 0.6

Cathode
 Anode
 ML2-

Panasonic ML2-N3-B
JEITA —
Code SOD-882

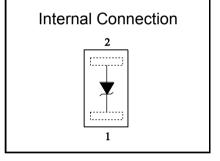
#### ■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Repetitive peak forward current	IFRM	200	mA
Total power dissipation *1	PT	100	mW
Electrostatic discharge *2	ESD	±8	kV
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note) \*1 PT = 100 mW achieved with a printed circuit board.

\*2 Test method:IEC61000\_4\_2

( C = 150 pF , R = 330  $\Omega$  , Contact discharge : 10 times )



#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 10 mA			1.0	V
Zener voltage *1, *2	VZ	IZ = 5  mA	19.00		21.00	V
Zener operating resistance	RZ	IZ = 5  mA			80	Ω
Zener rise operating resistance	RZK	IZ = 0.5 mA			100	Ω
Reverse current	IR	VR = 15 V			0.05	μΑ
Temperature coefficient of zener voltage *3	SZ	IZ = 5 mA		18.4		mV/°C

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
  - 2. Absolute frequency of input and output is 5 MHz.
  - 3. \*1 The temperature must be controlled 25 °C for VZ mesurement. VZ value measured at other temperature must be adjusted to VZ ( 25 °C )
    - \*2 VZ guaranteed 20 ms after current flow.
    - \*3 Tj = 25 °C to 150 °C

Rank classification

TIK Classification							
(	Code	M		0			
	Rank	M		No-rank			
	VZ	19.50	to	20.50	19.00	to	21.00
Marki	ng symbol		ZU			ZJ	

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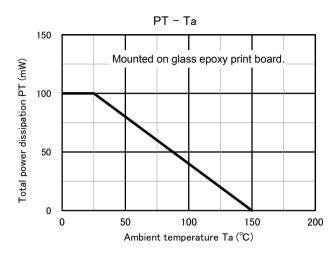
Established : 2013-04-20 Revised : 2017-01-10

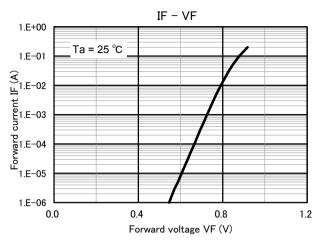
Zener Diode

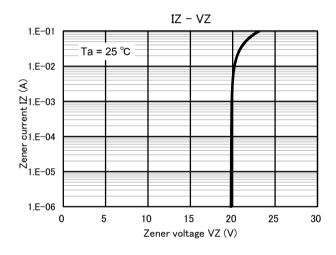
## DZ26200×0L

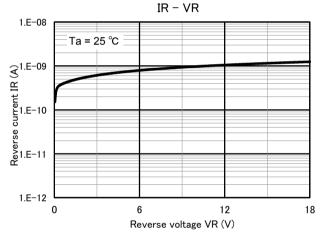
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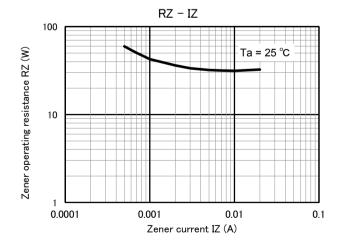
## Technical Data (reference)

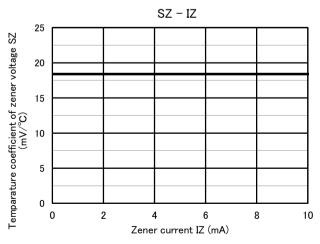












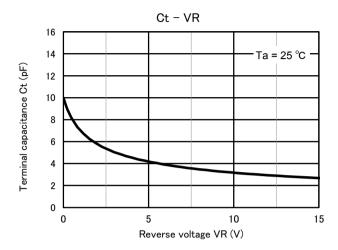
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Zener Diode

DZ26200×0L

# Technical Data (reference)



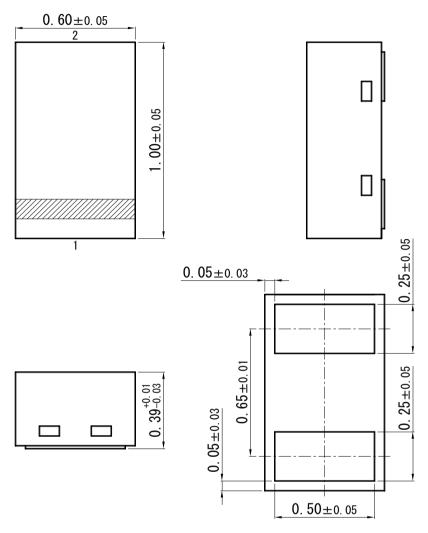
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Zener Diode

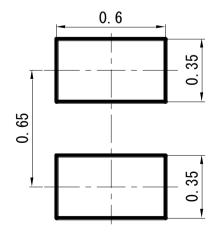
## DZ26200×0L

# **Panasonic**

ML2-N3-B Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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